	1 1		58817	resist WITH pattern	1.100.4
	1		30017	resist WITH pattern	USPAT;
					EPO; JPO;
	1				DERWENT;
			1		IBM_TDB
	2		3394	(resist WITH pattern) SAME photolithography	
	-		. 3331	(1035t With pattern) SAME photolidiography	USPAT;
	1				EPO; JPO;
			1		DERWENT;
	Ì		ļ		IBM_TDB
	3		4817	(resist WITH pattern) SAME photolithograph\$?	USPAT;
	i		,	(see see see see see see see see see se	
					EPO; JPO;
					DERWENT;
]				IBM_TDB
	4		6	((resist WITH pattern) SAME photolithograph\$?) SAME	USPAT;
				polariz\$?	EPO; JPO;
	· ·				
					DERWENT;
	۔ ا				IBM_TDB
	6		667	(mold\$? OR pressing) WITH photoresist	USPAT;
	l				EPO; JPO;
	ŀ				
	1			_	DERWENT;
	٠,		430	//	IBM_TDB
1	7		128	((mold\$? OR pressing) WITH photoresist) SAME etching	USPAT;
				· · · · · · · · · · · · · · · · · · ·	EPO; JPO;
					DERWENT;
				. *	
	8		162000	omboart2 OD shake-saish	IBM_TDB
	0		163000	emboss\$? OR photoresist	USPAT;
ļ			·	·	EPO; JPO;
-					DERWENT;
				,	IBM_TDB
	9	j	181	emboss\$? WITH photoresist	
- 1	,	i	101	cuipossà: AATTU buorotesist	USPAT;
ĺ					EPO; JPO;
		i			DERWENT;
-				·	IBM_TDB
	10		89	216/44[ccls]	USPAT;
		1			
J					EDO: IDO:
- 1		·		·	EPO; JPO;
.,!	· <u>/</u>			T. D. College Co.	DERWENT;
		umber	Hits	Search Text > same = : gish 80 HHs, was released	DERWENT;
	L N	umber	Hits 0		DERWENT; DB
		umber		(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)))	DERWENT; DB USPAT;
		umber			DERWENT; DB USPAT; EPO; JPO;
		umber		(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)))	DERWENT; DB USPAT; EPO; JPO; DERWENT;
	16	umber	0	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
		umber		(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)))	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT;
	16	umber	0	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT;
	16	umber	0	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)))	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO;
	16	umber	0	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)))	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT;
	16	umber	2	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	0	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)))	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT;
	16	umber	2	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO;
	16	umber	2	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; EPO; JPO; DERWENT;
	16	umber	2	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	2	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	2	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	2	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	2	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT;
	16	umber	0 2 43 1443	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	2	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	0 2 43 1443	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	0 2 43 1443	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT; EPO; JPO; DERWENT; EPO; JPO;
	16	umber	0 2 43 1443	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT;
	16	umber	0 2 43 1443 13592	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$? antireflect\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	0 2 43 1443	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT;
	16	umber	0 2 43 1443 13592	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$? antireflect\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	0 2 43 1443 13592	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$? antireflect\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT;
	16	umber	0 2 43 1443 13592	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$? antireflect\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	0 2 43 1443 13592	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$? antireflect\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	0 2 43 1443 13592 16824	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$? antireflect\$? ((AR ADJ1 coat\$?) OR antireflect\$? OR (anti ADJ1	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT;
	16	umber	0 2 43 1443 13592 16824	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$? antireflect\$?	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB
	16	umber	0 2 43 1443 13592 16824	(((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist)) AND heating ((mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid))) SAME (photoresist OR resist) (mold OR mask\$?) WITH (wire-grid OR (wire ADJ1 grid)) AR ADJ1 coat\$? antireflect\$? ((AR ADJ1 coat\$?) OR antireflect\$? OR (anti ADJ1	DERWENT; DB USPAT; EPO; JPO; DERWENT; IBM_TDB USPAT;